LITEON®
OPTOELECTRONICS

SMD LED

Product Data Sheet

LTW-670DS

Spec No.: DS22-2004-050

Effective Date: 09/03/2010

Revision: E

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

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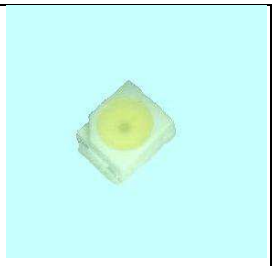
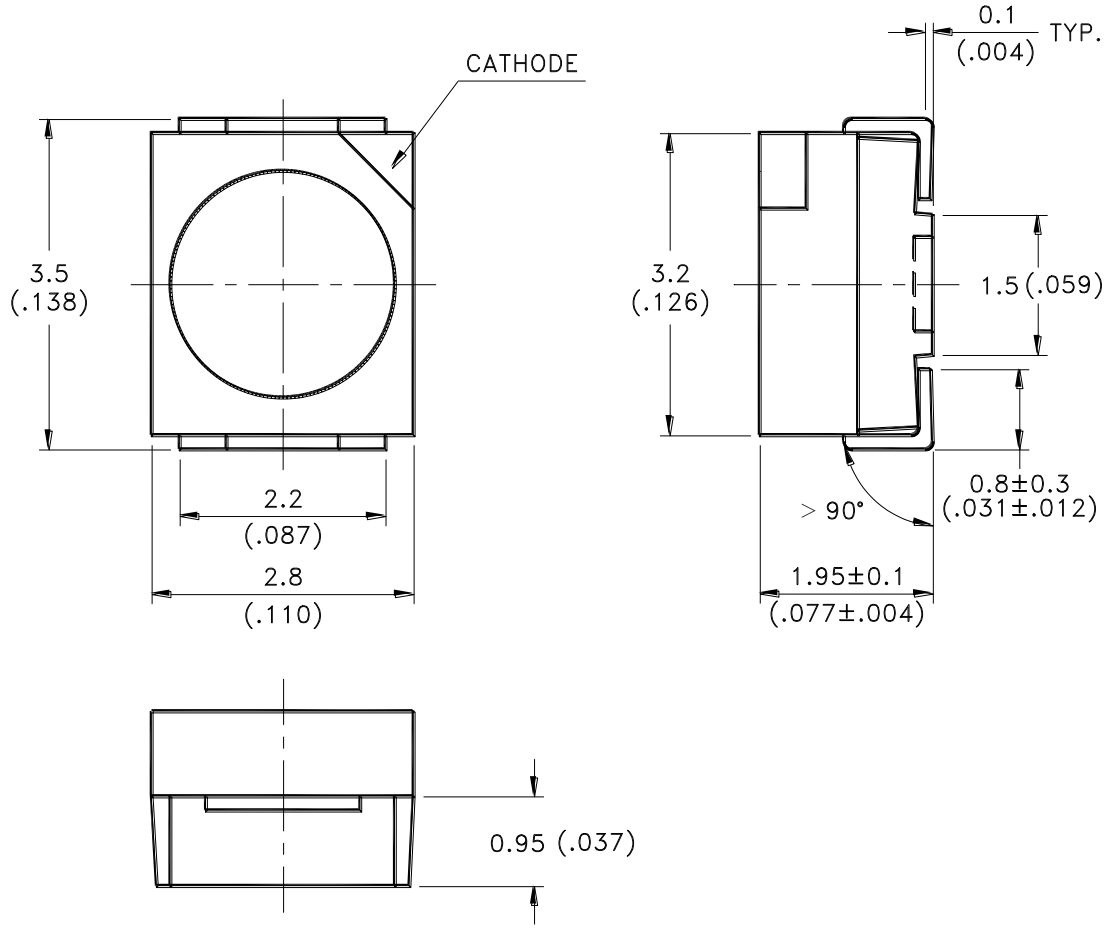


Features

* Package in 8mm tape on 7" diameter reels.
* Compatible with automatic placement equipment.
* Compatible with infrared and vapor phase reflow solder process.
* EIA STD package.
* I.C. compatible.
* Meet green product and Pb-free(According to RoHS)

Package Dimensions



Part No.	Lens Color	Source Color
LTW-670DS	Yellow	InGaN White

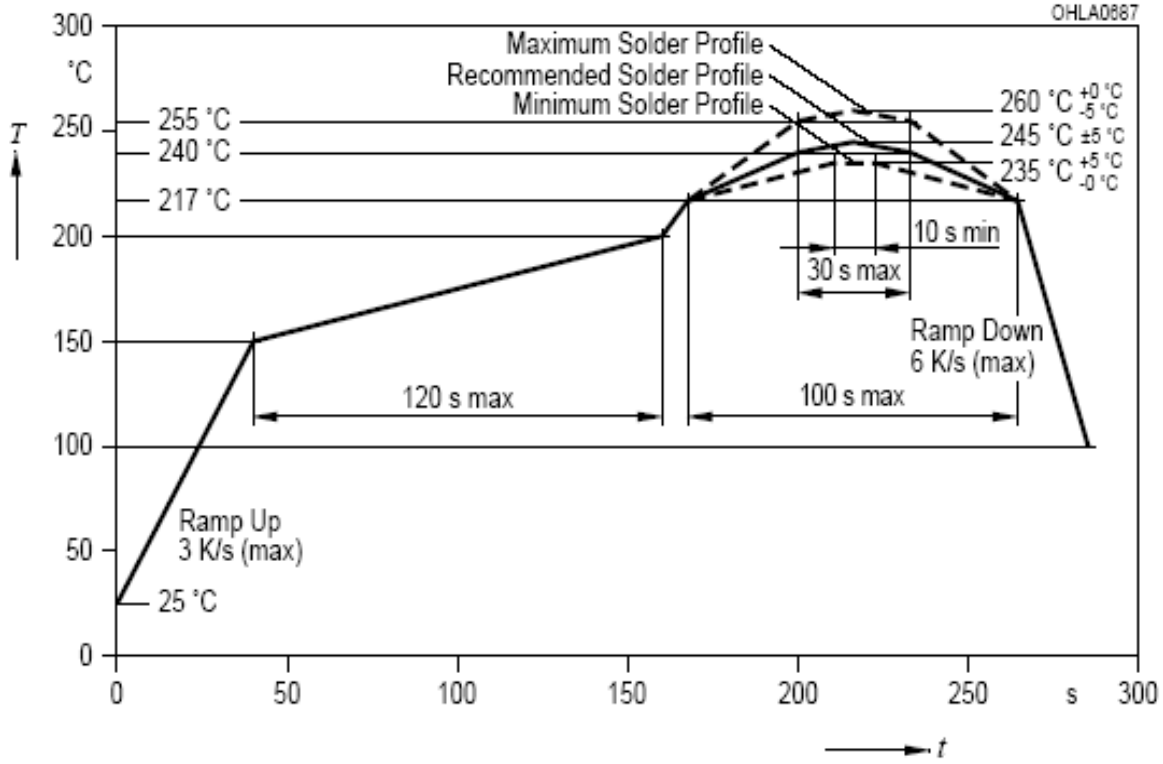
Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2 mm (.008") unless otherwise noted.

Absolute Maximum Ratings at Ta=25℃

Parameter	LTW-670DS	Unit
Power Dissipation	120	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
DC Forward Current	30	mA
Reverse Voltage	5	V
Operating Temperature Range	-30℃ to + 85℃	
Storage Temperature Range	-40℃ to + 100℃	
Wave Soldering Condition	260℃ For 5 Seconds	

Note: Operating the LED (in an application) under reverse bias condition might result in damage or failure of the component.

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020D)



Electrical Optical Characteristics At Ta=25℃

Parameter	Symbol	Part No. LTW-	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I_V	670DS	710	1100	1800	mcd	I_F = 20mA Note 1, 2, 5
Luminous Flux	Φ_V	670DS		2800		mlm	I_F = 20mA Note 1, 2, 5
Viewing Angle	2θ 1/2	670DS		120		deg	Fig.6
Chromaticity Coordinates	x	670DS		0.31			I_F = 20mA Note 3, 5 Fig.1
	y			0.30			
Forward Voltage	V_F	670DS	3.0	3.5	3.7	V	I_F = 20mA
Reverse Current	I_R	670DS			10	μA	V_R = 5V

Note : 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. Iv classification code is marked on each packing bag.

3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.

4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. CAS140B is the test standard for the chromaticity coordinates (x, y) & IV.

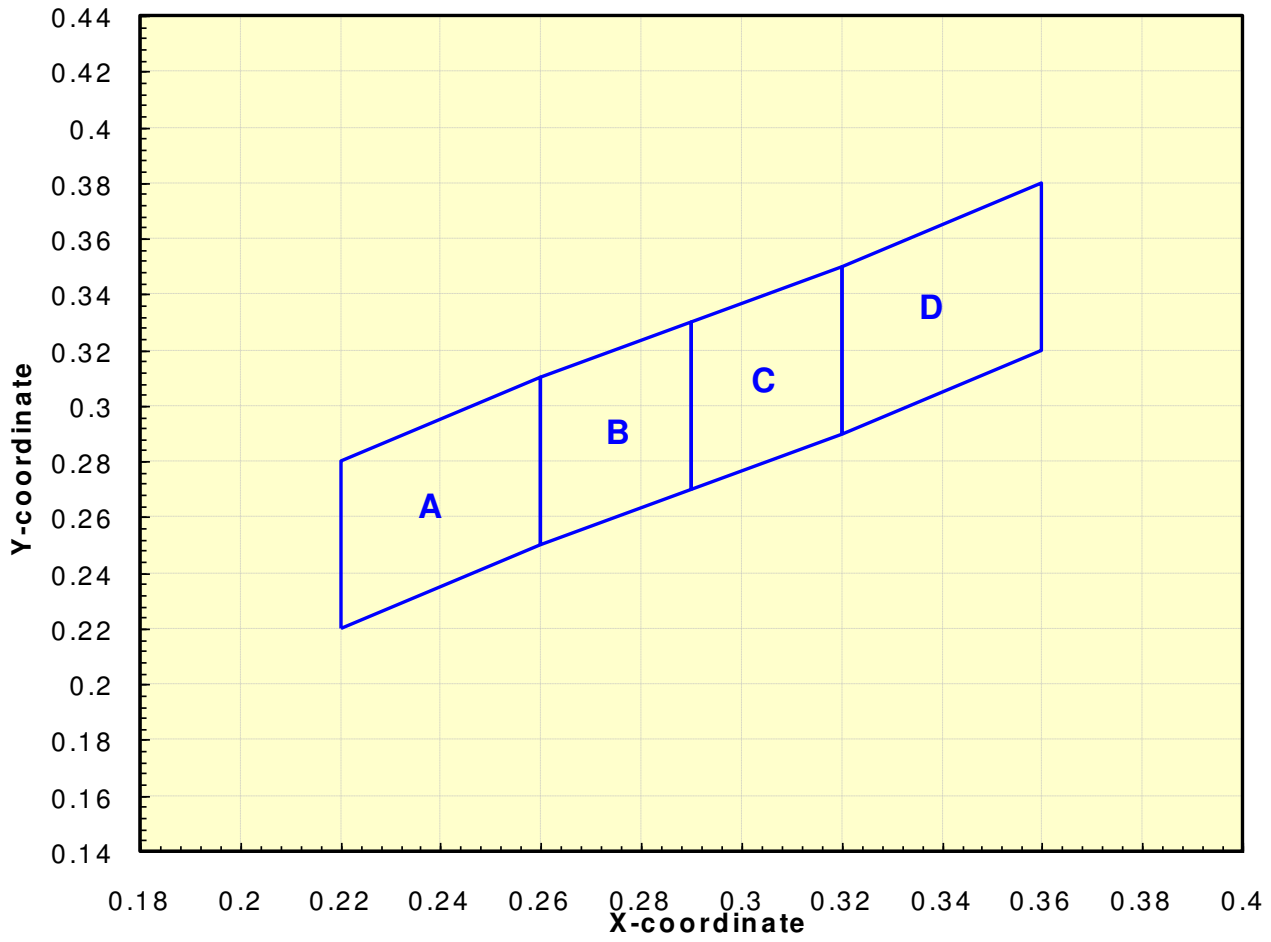
Bin Code List

IV Spec. Table		
IV Bin	Luminous Intensity (mcd) at I_F = 20mA	
	Min.	Max.
V	710	1120
W	1120	1400
X	1400	1800

Tolerance on each Luminous Intensity bin is +/- 15%.

Hue Spec. Table					
Hue Bin	Color bin limits at I_F = 20mA				
	CIE 1931 Chromaticity coordinates				
A	x	0.22	0.22	0.26	0.26
	y	0.22	0.28	0.31	0.25
B	x	0.26	0.26	0.29	0.29
	y	0.25	0.31	0.33	0.27
C	x	0.29	0.29	0.32	0.32
	y	0.27	0.33	0.35	0.29
D	x	0.32	0.32	0.36	0.36
	y	0.29	0.35	0.38	0.32

Tolerance on each Hue (x, y) bin is +/- 0.02


0.44
0.42
0.4
0.38
0.36
0.34
0.32
0.3
0.28
0.26
0.24
0.22
0.2
0.18
0.16
0.14
Y-coordinate
0.18
0.2
0.22
0.24
0.26
0.28
0.3
0.32
0.34
0.36
0.38
0.4
X-coordinate
A
B
C
D

Typical Electrical / Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

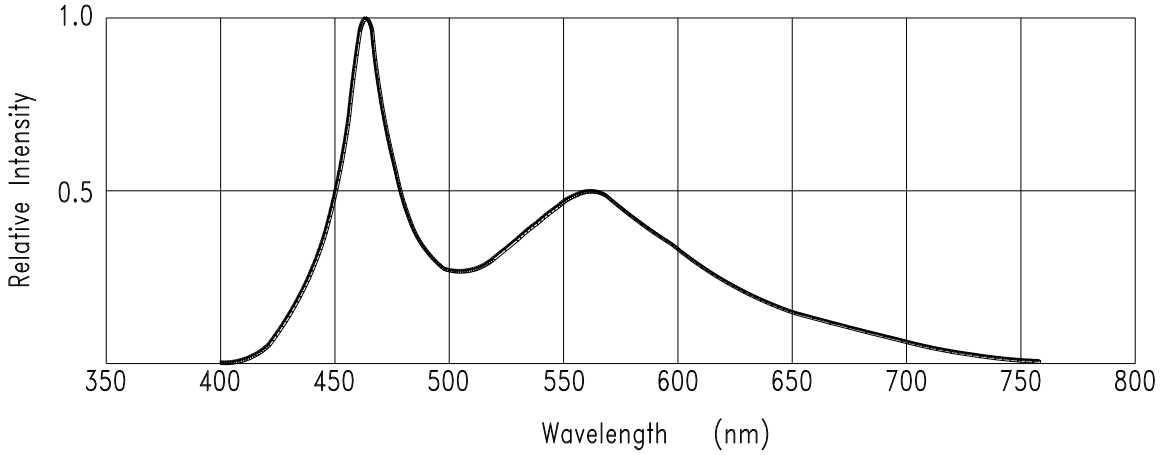


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

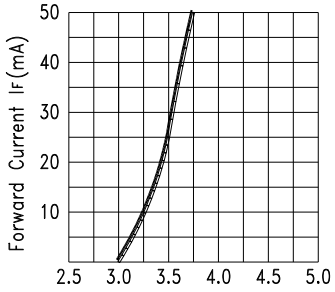


Fig.2 Forward Current vs. Forward Voltage

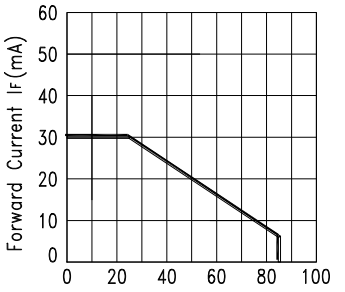


Fig.3 Forward Current Derating Curve

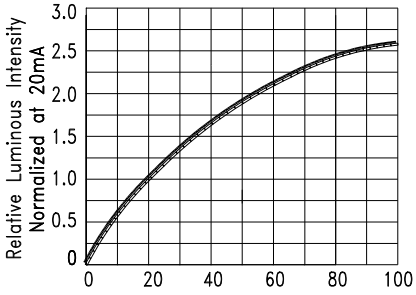


Fig.4 Relative Luminous Intensity vs. Forward Current

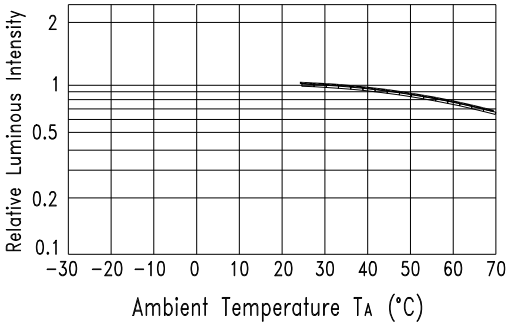


Fig.5 Luminous Intensity vs. Ambient Temperature

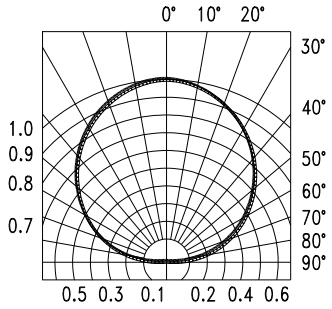


Fig.6 Spatial Distribution

User Guide

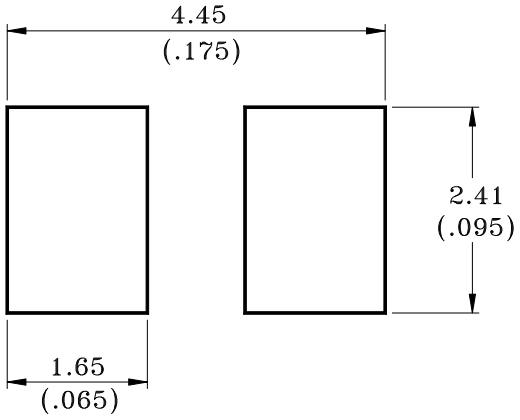
Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package.
If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

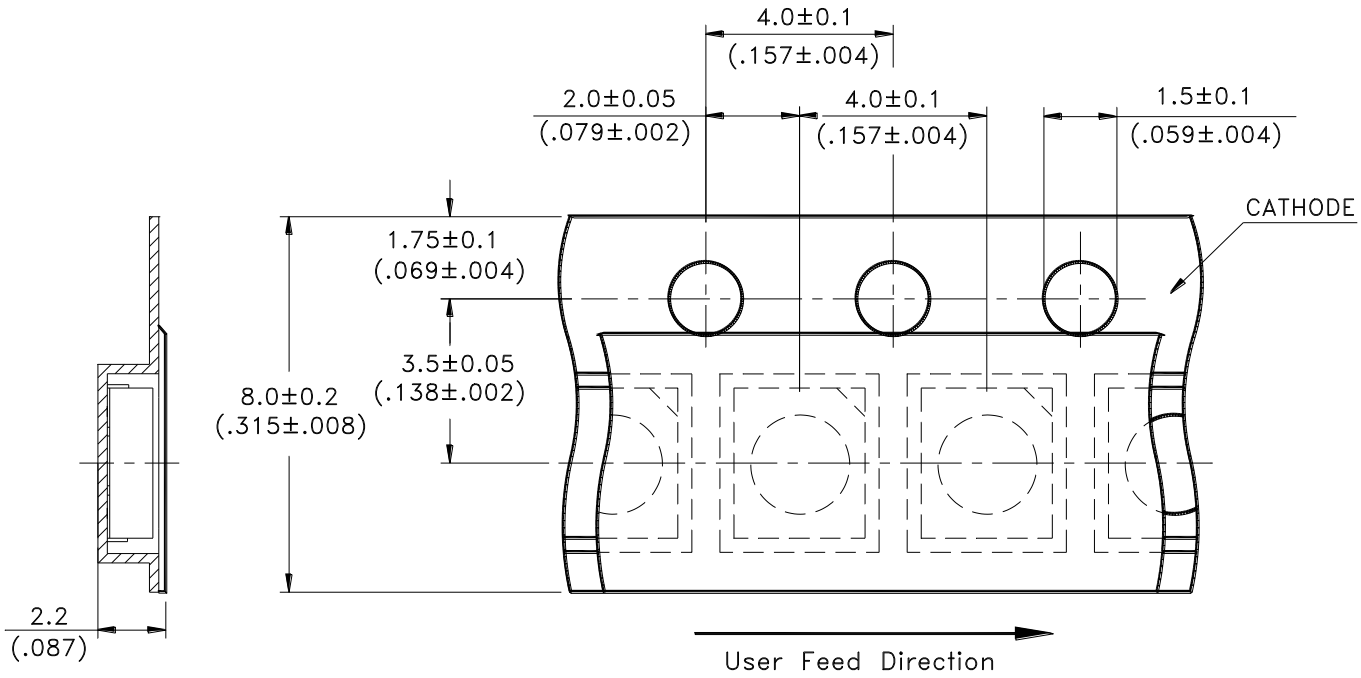
Recommend Printed Circuit Board Attachment Pad

Infrared / vapor phase

Reflow Soldering



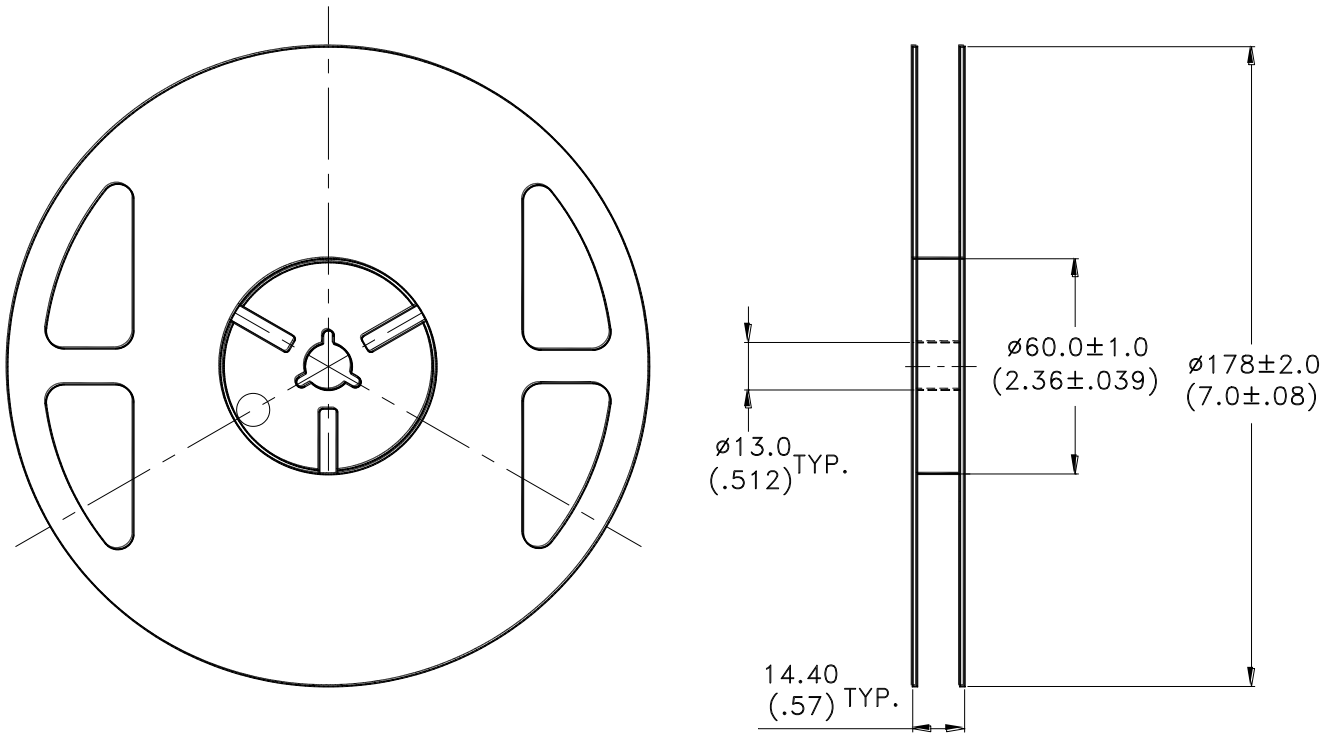
Package Dimensions of Tape



Note:

1. All dimensions are in millimeters (inches).

Package Dimensions of Reel



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-2000 pieces per reel.
3. Minimum packing quantity is 500 pieces for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with EIA-481-1-B specifications.

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

This product is qualified as Moisture sensitive Level 3 per JEDEC J-STD-020 Precaution when handing this moisture sensitive product is important to ensure the reliability of the product.

The package is sealed:

The LEDs should be stored at 30°C or less and 90%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The LEDs should be stored at 30°C or less and 60%RH or less. Moreover, the LEDs are limited to solder process within 168hrs. If the Humidity Indicator shows the pink color in 10% even higher or exceed the storage limiting time since opened, that we recommended to baking LEDs at 60°C at least 48hrs. To seal the remainder LEDs return to package, it's recommended to be with workable desiccants in original package.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

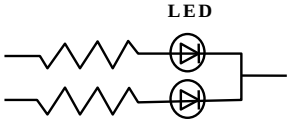
Recommended soldering conditions:

Reflow soldering		Wave Soldering		Soldering iron	
Pre-heat	120~150°C	Pre-heat	100°C Max.	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Pre-heat time	60 sec. Max.	Soldering time	3 sec. Max.
Soldering Temp.	260°C Max.	Solder wave	260°C Max.		(one time only)
Soldering time	30 sec. Max.	Soldering time	10 sec. Max.		

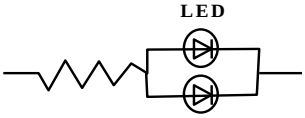
5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
	High Temperature High Humidity Storage	Ta= 65±5℃,RH= 90～95% *Test Time= 240HRS±2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= 105±5℃ *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5℃ *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
Environmental Test	Temperature Cycling	105℃ ～ 25℃ ～ -55℃ ～ 25℃ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	85 ± 5℃ ～ -40℃ ± 5℃ 10mins 10mins 100 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	IR-Reflow	Ramp-up rate(217℃ to Peak) +3℃/ second max Temp. maintain at 175(±25)℃ 180 seconds max Temp. maintain above 217℃ 60-150 seconds Peak temperature range 260℃+0/-5℃ Time within 5°C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6℃/second max	MIL-STD-750D:2031.2 J-STD-020B
	Solderability	T.sol= 245 ± 5℃ Immersion time 3±0.5 sec Immersion rate 25±2.5 mm/sec Coverage ≧95% of the dipped surface	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

9. Suggested Checking List

Training and Certification

1. Everyone working in a static-safe area is ESD-certified?
2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

1. Static-safe workstation or work-areas have ESD signs?
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?
4. Each work surface mats grounding is good?

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
2. If conductive footwear used, conductive flooring also present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
5. All wrist strap or heel strap checkers calibration up to date?
   Note: *50V for Blue LED.

Device Handling

1. Every ESDS items identified by EIA-471 labels on item or packaging?
2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

1. Audit result reported to entity ESD control coordinator?
2. Corrective action from previous audits completed?
3. Are audit records complete and on file?